SHIGA7.004APC PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Maruyama et al.

Appl. No. : 10/522,036

Filed : January 19, 2005

For : CHEMICAL AMPLIFICATION

TYPE POSITIVE PHOTORESIST COMPOSITION AND RESIST PATTERN FORMING METHOD

Examiner : Lee, Sin J

Group Art Unit : 1752

AMENDMENT AND RESPONSE TO OFFICE ACTION

Commissioner for Patents P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

In response to the final Office Action mailed September 20, 2007, please consider the following amendments and remarks.

Amendments to the claims begin on page 2 of this paper.

Remarks begin on page 10 of this paper.